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**Systems Alliance**

**VPP-9: Instrument Vendor Abbreviations**

**Revision 4.35**

**August 8, 2024**

**VPP-9 Revision History**

This section is an overview of the revision history of the VPP-9 specification.

**Revision 1.0, November 28, 1994**

This edition reflects the first edition of this specification.

**Revision 1.1, December 12, 1994**

This edition reflects the following additions to the instrument vendor abbreviations table:   
Phase Metrics and Radisys Corporation.

**Revision 1.2, January 6, 1995**

This edition reflects the following addition to the instrument vendor abbreviations table:   
Schlumberger Technologies.

**Revision 1.3, February 24, 1995**

This edition reflects the following addition to the instrument vendor abbreviations table:   
Wandel & Goltermann.

**Revision 1.4, July 7, 1995**

This edition reflects the following additions to the instrument vendor abbreviations table:   
Scientific Research Corporation and Sony/Tektronix Corporation.

**Revision 1.5, November 13, 1995**

This edition reflects the following additions to the instrument vendor abbreviations table:   
ASCOR Incorporated and Talon Instruments.

**Revision 1.6, February 28, 1996**

This edition reflects the following additions to the instrument vendor abbreviations table:   
B&B Technologies, Morrow Technologies, Scicom, and Teradyne.

**Revision 1.7, March 13, 1996**

This edition reflects the following addition to the instrument vendor abbreviations table:   
Morrow Technologies Corporation.

**Revision 1.8, May 15, 1996**

This edition reflects the following addition to the instrument vendor abbreviations table:   
VXI Technology, Inc.

**Revision 1.9, November 5, 1996**

This edition reflects the following addition to the instrument vendor abbreviations table:   
Spectrum Signal Processing, Inc.

**Revision 1.10, November 26, 1996**

This edition reflects the following addition to the instrument vendor abbreviations table:   
Marconi Instruments.

**Revision 2.0, December 4, 1998**

This edition reflects the following addition to the instrument vendor abbreviations table:   
IFR. The information regarding contacting the Alliance was also updated. References to the VPP-5 Component Knowledge Base specification, which was obsoleted by the alliance, were removed.

**Revision 2.1, May 20, 1999**

This edition reflects the following additions to the instrument vendor abbreviations table:   
AIM GmbH, Pickering Interfaces, and Serendipity Systems, Inc. Some minor changes were made to fix an incorrect alphabetization and a double entry in the instrument vendor abbreviations table.

**Revision 2.2, July 13, 1999**

This edition reflects the following additions to the instrument vendor abbreviations table:   
AD Ando Electronics added.

**Revision 2.3, July 19, 1999**

This edition reflects the following additions to the instrument vendor abbreviations table:   
Changed Ando Electronics to Ando Electric Company Limited, the correct company name.

**Revision 2.4, August 3, 1999**

This edition reflects the following additions to the instrument vendor abbreviations table:

AG Agilent Technologies added.

**Revision 2.5, August 24, 1999**

This edition reflects the following change and additions to the instrument vendor abbreviations table:

Agilent Technologies identifier changed from AT to AG. gnubi communications, Inc. (sic) added.

**Revision 2.6, October 27, 1999**

This edition reflects the following additions to the instrument vendor abbreviations table:

BU Bustec Production Ltd. identifier added.

**Revision 2.7, December 10, 1999**

This edition reflects the following additions to the instrument vendor abbreviations table:

FL Fluke Corporation and Rohde & Schwarz GmbH. identifiers added.

**Revision 2.8, January 7, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

YK Yokogawa Electric Corp., Directed Perceptions Inc., Audio Precision Inc., and

NT Neutrik AG identifiers added.

**Revision 2.9, May 12, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

AV Advantest Corporation.

**Revision 3.0, June 1, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

KI Kikusui Inc. and AO AOIP Instrumentation identifiers added.

**Revision 3.1, June 23, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

AQ Acquiris identifier added.

**Revision 3.2, August 4, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

MS Microscan identifier added.

**Revision 3.3, December 7, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

AU Anritsu Company and KE Keithley Instruments identifiers added.

**Revision 3.4, December 12, 2000**

This edition reflects the following additions to the instrument vendor abbreviations table:

BA BAE Systems identifier added.

**Revision 3.5, December 6, 2001**

This edition reflects the following additions to the instrument vendor abbreviations table:

BK Bruel & Kjaer identifier added.

**Revision 3.6, May 13, 2002**

This edition reflects the following additions to the instrument vendor abbreviations table:

AF Aeroflex Laboratories identifier added.

**Revision 3.7, February 14, 2008**

Updated the introduction to reflect the IVI Foundation organization changes. Replaced Notice with text used by IVI Foundation specifications.

**Revision 3.7, April 14, 2008**

Editorial change to update the IVI Foundation contact information in the Important Information section to remove obsolete address information and refer only to the IVI Foundation web site.

**Revision 3.8, October 2, 2008**

This edition reflects the following additions to the instrument vendor abbreviations table:

PW Pacific Mindworks identifier added.

**Revision 3.9, November 3, 2008**

This edition reflects the following additions to the instrument vendor abbreviations table:

TS Test & Measurement Systems Inc. identifier added.

**Revision 4.0, December 12, 2008**

This edition reflects the following additions to the instrument vendor abbreviations table:

LC LeCroy identifier added.

**Revision 4.1, January 27, 2009**

Editorial change to update the Section 2.1 Introduction to include email contact information

for registering vendor prefixes.

**Revision 4.2, April 2, 2009**

This edition reflects the following additions to the instrument vendor abbreviations table:

PC Picotest identifier added.

**Revision 4.3, May 29, 2009**

This edition reflects the following additions to the instrument vendor abbreviations table:

DV IBEKO POWER AB identifier added.

**Revision 4.4, August 3, 2009**

This edition reflects the following additions to the instrument vendor abbreviations table:

UN Holding “Informtest” identifier added.

**Revision 4.5, May 13, 2010**

This edition reflects the following additions to the instrument vendor abbreviations table:

AT Thurlby Thandar Instruments Limited and VE Vencon Technologies identifiers added.

**Revision 4.6, May 26, 2010**

This edition reflects the following additions to the instrument vendor abbreviations table:

US Universal Switching Corporation identifier added.

**Revision 4.7, August 2, 2010**

This edition reflects the following additions to the instrument vendor abbreviations table:

CM CMC Labs identifier added.

**Revision 4.8, October 18, 2011**

This edition reflects the following additions to the instrument vendor abbreviations table:

AC Applicos BV identifier added.

**Revision 4.9, October 19, 2012**

This edition reflects the following additions to the instrument vendor abbreviations table:

FO fos4X GmbHidentifier added.

**Revision 4.10, October 29, 2012**

This edition reflects the following additions to the instrument vendor abbreviations table:

ML MIT Lincoln Laboratory identifier added.

**Revision 4.11, October 30, 2013**

This edition reflects the following additions to the instrument vendor abbreviations table:

LP LitePoint Corporation identifier added.

**Revision 4.12, Nov. 7, 2013**

This edition reflects the following additions to the instrument vendor abbreviations table:

ZT ZTEC Instruments identifier added.

**Revision 4.13, Jan. 9, 2014**

This edition reflects the following additions to the instrument vendor abbreviations table:

CI Cambridge Instruments identifier added.

**Revision 4.14, Feb. 5, 2014**

This edition reflects the following additions to the instrument vendor abbreviations table:

KT Reserved for Keysight Technologies (formerly part of Agilent Technologies).

**Revision 4.15, Aug. 1, 2014**

This edition reflects the following additions to the instrument vendor abbreviations table:

KT Keysight Technologies

**Revision 4.16, Oct. 9, 2014**

This edition reflects the following additions to the instrument vendor abbreviations table:

AX AMETRIX Instruments identifier added.

**Revision 4.17, Jan. 14, 2015**

This edition reflects the following additions to the instrument vendor abbreviations table:

IS Intepro Systems identifier added.

**Revision 4.18, April 19, 2015**

This edition reflects the following additions to the instrument vendor abbreviations table:

SP Spitzenberger & Spies GmbH & Co. KG identifier added.

**Revision 4.19, April 20, 2015**

This edition reflects the following additions to the instrument vendor abbreviations table:

ND Newland Design + Associates, Inc. identifier added.

**Revision 4.20, November 14, 2016**

This edition reflects the following additions to the instrument vendor abbreviations table:

PE PesMatrix Inc. identifier added.

**Revision 4.21, December 15, 2016**

This edition reflects the following additions to the instrument vendor abbreviations table:

RF ThinkRF Corporation identifier added.

**Revision 4.22, December 19, 2016**

This edition reflects the following additions to the instrument vendor abbreviations table:

HH Hoecherl & Hackl GmbH identifier added.

**Revision 4.23, December 22, 2016**

This edition reflects the following additions to the instrument vendor abbreviations table:

EX EXFO Inc. identifier added.

**Revision 4.24, January 3, 2017**

This edition reflects the following additions to the instrument vendor abbreviations table:

IT Instrumental Systems Corporation identifier added.

**Revision 4.25, March 13, 2017**

This edition reflects the following additions to the instrument vendor abbreviations table:

CE Instrumental Systems Corporation identifier added.

**Revision 4.26, June 28, 2017**

This edition reflects the following additions to the instrument vendor abbreviations table:

CE Chyng Hong Electronic Co., Ltd identifier added.

**Revision 4.27, July 13, 2017**

This edition reflects the following additions to the instrument vendor abbreviations table:

AT Astronics Test Systems Inc. identifier added.

**Revision 4.28, Oct. 17, 2017**

This edition reflects the following additions to the instrument vendor abbreviations table:

EA Elektro-Automatik GmbH identifier added.

**Revision 4.29, Jan. 3, 2018**

This edition reflects the following additions to the instrument vendor abbreviations table:

WZ Welzek identifier added.

**Revision 4.30, Mar. 6, 2018**

This edition reflects the following additions to the instrument vendor abbreviations table:

SI SignalCraft Technologies Inc. identifier added.

**Revision 4.31, May 4, 2020**

This edition reflects the following additions to the instrument vendor abbreviations table:

TP TSE Plazotta identifier added.

**Revision 4.32, March 2, 2022**

This edition reflects the following additions to the instrument vendor abbreviations table:

RQ Raditeq identifier added.

## Revision 4.33, September 28, 2023

This edition reflects the following additions to the instrument vendor abbreviations table:

DK Druck Ltd identifier added.

## Revision 4.34, December 12, 2023

This edition reflects one addition to Table 3-1: Instrument Vendor Abbreviations:

* LadyBug Technologies LLC – LB

## Revision 4.35, August 8, 2023

This edition reflects additions to Table 3-1: Instrument Vendor Abbreviations:

* MKS Newport – NP
* BK Precision - BP

**NOTICE**

VPP-9: *Instrument Vendor Abbreviations* is authored by the IVI Foundation member companies. For a vendor membership roster list, please visit the IVI Foundation web site at www.ivifoundation.org.

The IVI Foundation wants to receive your comments on this specification. You can contact the Foundation through the web site at www.ivifoundation.org.

**Warranty**

The IVI Foundation and its member companies make no warranty of any kind with regard to this material, including, but not limited to, the implied warranties of merchantability and fitness for a particular purpose. The IVI Foundation and its member companies shall not be liable for errors contained herein or for incidental or consequential damages in connection with the furnishing, performance, or use of this material.

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**Table**

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# Section 1

# Introduction to the VXI*plug&play* Systems Alliance and the IVI Foundation

The VXI*plug&play* Systems Alliance was founded by members who shared a common commitment to end-user success with open, multivendor VXI systems. The alliance accomplished major improvements in ease of use by endorsing and implementing common standards and practices in both hardware and software, beyond the scope of the VXIbus specifications. The alliance used both formal and de facto standards to define complete system frameworks. These standard frameworks gave end-users "plug & play" interoperability at both the hardware and system software level.

The IVI Foundation is an organization whose members share a common commitment to test system developer success through open, powerful, instrument control technology. The IVI Foundation’s primary purpose is to develop and promote specifications for programming test instruments that simplify interchangeability, provide better performance, and reduce the cost of program development and maintenance.

In 2002, the VXI*plug&play* Systems Alliance voted to become part of the IVI Foundation. In 2003, the VXI*plug&play* Systems Alliance formally merged into the IVI Foundation. The IVI Foundation has assumed control of the VXI*plug&play* specifications, and all ongoing work will be accomplished as part of the IVI Foundation.

All references to VXI*plug&play* Systems Alliance within this document, except contact information, were maintained to preserve the context of the original document.

# Section 2

# Overview of Instrument Vendor Abbreviations Specification

## 2.1 Introduction

To uniquely identify all VXI*plug&play* components, filenames and function names begin with a two-character abbreviation that uniquely identifies the supplier of the component.

The two-character abbreviations are maintained by the IVI Foundation. Contact the IVI Foundation ([admin@ivifoundation.org](mailto:admin@ivifoundation.org)) to register a new vendor prefix. Vendors do not need to join the IVI Foundation to obtain a defined two-character abbreviation.

## 2.2 References

Several other VXI*plug&play* Systems Alliance documents and specifications are related to this specification. These other related documents include the following:

• VPP-1 *Charter Document*

• VPP-2 *System Frameworks Specification*

• VPP-3.1 *Instrument Drivers Architecture and Design Specification*

• VPP-3.2 *Instrument Driver Functional Body Specification*

• VPP-3.3 *Instrument Driver Interactive Developer Interface Specification*

• VPP-3.4 *Instrument Driver Programmatic Developer Specification*

• VPP-4.*x* *Virtual Instrument Software Architecture Specifications*

• VPP-6 *Installation and Packaging Specification*

• VPP-7 *Soft Front Panel Specification*

## 2.3 Conventions

The following headings appear on paragraphs throughout this specification. These headings give special meaning to the paragraphs.

*Rules* must be followed to ensure compatibility with the system framework. A rule is characterized by the words **SHALL** or **SHALL NOT** in bold upper case characters. These words are not used in this manner for any other purpose.

*Recommendations* contain advice to implementors. This advice affects the usability of the final device. Recommendations are included in this standard to draw attention to particular characteristics that the authors believe to be important to end-user success.

*Permissions* authorize specific implementations or uses of system components. A permission is characterized by the word **MAY** in bold upper-case characters. These permissions are granted to ensure that specific system framework components are well defined and can be tested for compatibility and interoperability.

*A Note on the text of the specification:* Any text that appears without heading should be considered a description of the standard and how the architecture was intended to operate. The purpose of this text is to give the reader a deeper understanding of the intentions of the specification, including the underlying model and specific required features. The implementor of this standard should ensure that a particular implementation does not conflict with the text of the standard.

# Section 3

# Instrument Vendor Abbreviations

## 3.1 Introduction

To uniquely identify all VXI*plug&play* components, filenames and function names begin with a two-character abbreviation that uniquely identifies the supplier of the component.

The two-character abbreviations are maintained by the IVI Foundation. A developer who wants a new prefix must notify the IVI Foundation. Vendors do not need to join the IVI Foundation to obtain a defined two-character abbreviation.

## 3.2 Instrument Vendor Abbreviations

**RULE 3.1**

The two-character abbreviations used for naming VXI*plug&play* components **SHALL** be as defined in Table 3-1, *Instrument Vendor Abbreviations*.

**RULE 3.2**

Additions to the Instrument Vendor Abbreviations table **SHALL NOT** require a vote of the general membership.

**RULE 3.3**

When new members are added to the Instrument Vendor Abbreviations table, the minor index of the revision of this specification **SHALL** be incremented.

Table 3-1. Instrument Vendor Abbreviations

| **Vendor** | **Two Character Abbreviation** |
| --- | --- |
| Acqiris | AQ |
| Applicos BV | AC |
| Advantest Corporation | AV |
| Aeroflex Laboratories | AF |
| Agilent Technologies | AG |
| AIM GmbH | AI |
| AMETRIX Instruments | AX |
| AMP Incorporated | AM |
| Analogic, Corp. | AN |
| Ando Electric Company Limited | AD |
| Anritsu Company | AU |
| Astronics Test Systems Inc. | AT |
| AOIP Instrumentation | AO |
| ASCOR Incorporated | AS |
| Audio Precision, Inc | AP |
| B&B Technologies | BB |
| BAE Systems | BA |
| Bruel & Kjaer | BK |
| BK Precision | BP |
| Bustec Production Ltd. | BU |
| CAL-AV Labs, Inc. | CA |
| Cambridge Instruments | CI |
| C&H Technologies, Inc. | CH |
| Chyng Hong Electronic Co., Ltd | CE |
| CMC Labs | CM |
| Compressor Controls Corporation | CC |
| CYTEC Corporation | CY |
| Directed Perceptions Inc. | DP |
| Druck Ltd. | DK |
| DSP Technology Inc. | DS |
| EA Elektro-Automatik GmbH | EA |
| EIP Microwave, Inc. | EI |
| EXFO Inc. | EX |
| Fluke Company Inc. | FL |
| fos4X GmbH | FO |
| GenRad | GR |
| Giga-tronics, Inc. | GT |
| gnubi communications, Inc. | GN |
| Hewlett-Packard Company | HP |
| Hoecherl & Hackl GmbH | HH |
| Holding “Informtest” | UN |
| Intepro Systems | IS |
| IBEKO POWER AB | DV |
| IFR | IF |
| Instrumental Systems Corporation | IT |
| Instrumentation Engineering, Inc. | IE |
| Integrated Control Systems | IC |
| Keithley Instruments | KE |
| Kepco, Inc. | KP |
| Keysight Technologies | KT |
| Kikusui Inc. | KI |
| LadyBug Technologies LLC | LB |
| LeCroy | LC |
| LitePoint Corporation | LP |
| MAC Panel Company | MP |
| ManTech Test Systems | MT |
| Marconi Instruments | MI |
| Microscan | MS |
| MIT Lincoln Laboratory | ML |
| National Instruments Corp. | NI |
| MKS Newport | NP |
| NEUTRIK AG | NT |
| Newland Design + Associates, Inc. | ND |
| NH Research | NH |
| North Atlantic Instruments | NA |
| Pacific MindWorks, Inc. | PW |
| PesMatrix Inc. | PE |
| Phase Metrics | PM |
| Pickering Interfaces | PI |
| Picotest | PC |
| Power-Tek Inc. | PT |
| Racal Instruments, Inc. | RI |
| Raditeq | RQ |
| Radisys Corp. | RA |
| Rohde & Schwarz GmbH | RS |
| Schlumberger Technologies | SL |
| Scicom | SC |
| Scientific Research Corporation | SR |
| Serendipity Systems, Inc. | AU |
| SignalCraft Technologies Inc. | SI |
| Sony/Tektronix Corporation | ST |
| Spectrum Signal Processing, Inc. | SS |
| Spitzenberger & Spies GmbH | SP |
| Talon Instruments | TA |
| Tektronix, Inc. | TK |
| Teradyne | TE |
| Test & Measurement Systems Inc. | TS |
| ThinkRF Corporation | RF |
| Thurlby Thandar Instruments Limited Transmagnetics, Inc. | AT |
| Transmagnetics, Inc. | TM |
| TSE Plazotta | TP |
| TTI Testron, Inc. | TT |
| Universal Switching Corporation | US |
| Vencon Technologies Inc. | VE |
| Versatile Power | XR |
| Virginia Panel, Corp. | VP |
| VXI Technology, Inc. | VT |
| VXIbus Associates, Inc. | VA |
| Wavetek Corp. | WT |
| Wandel & Goltermann | WG |
| Welzek | WZ |
| Yokogawa Electric Corporation | YK |
| ZTEC | ZT |